

**PCN#20250130000.1**  
**Qualification of additional BOM materials for selected devices**  
**Change Notification / Sample Request**

**Date:** January 30, 2025

**To:** MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team  
SC Business Services

**20250130000.1**  
**Change Notification / Sample Request**  
**Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
MSP430I2031TPW	MSP430I2031TPW
MSP430I2041TPWR	MSP430I2041TPWR
PGA281AIPWR	NULL
MUX36D08IPW	MUX36D08IPW
CD74HC154M96	NULL
MUX36S16IPWR	MUX36S16IPWR
UCC28951PWT	UCC28951PWT
MSP430I2040TPWR	MSP430I2040TPWR
MUX507IPWR	NULL
MUX506IPWR	NULL
MSP430I2021TPW	MSP430I2021TPW
MSP430I2041TPW	MSP430I2041TPW
PGA281AIPW	PGA281AIPW
TLC6C598PWR	TLC6C598PWR
MSP430I2040TPWR	595-MSP430I2040TPWR
BQ7790511PW	BQ7790511PW
MUX36D08IPW	595-MUX36D08IPW
PGA302EPWT	NULL
UCC28951PWR	UCC28951PWR
MSP430I2040TPW	MSP430I2040TPW

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20250130000.1			<b>PCN Date:</b>	January 30, 2025																														
<b>Title:</b>	Qualification of additional BOM materials for selected devices																																		
<b>Customer Contact:</b>		Change Management team		<b>Dept:</b>	Quality Services																														
<b>Proposed 1<sup>st</sup> Ship Date:</b>		April 30, 2025		<b>Sample Requests accepted until:</b>	March 31, 2025*																														
<b>*Sample requests received after March 31, 2025 will not be supported.</b>																																			
<b>Change Type:</b> <table border="1"> <tr> <td><input type="checkbox"/></td> <td>Assembly Site</td> <td><input type="checkbox"/></td> <td>Design</td> <td><input type="checkbox"/></td> <td>Wafer Bump Material</td> </tr> <tr> <td><input type="checkbox"/></td> <td>Assembly Process</td> <td><input type="checkbox"/></td> <td>Data Sheet</td> <td><input type="checkbox"/></td> <td>Wafer Bump Process</td> </tr> <tr> <td><input checked="" type="checkbox"/></td> <td>Assembly Materials</td> <td><input type="checkbox"/></td> <td>Part number change</td> <td><input type="checkbox"/></td> <td>Wafer Fab Site</td> </tr> <tr> <td><input type="checkbox"/></td> <td>Mechanical Specification</td> <td><input type="checkbox"/></td> <td>Test Site</td> <td><input type="checkbox"/></td> <td>Wafer Fab Material</td> </tr> <tr> <td><input type="checkbox"/></td> <td>Packing/Shipping/Labeling</td> <td><input type="checkbox"/></td> <td>Test Process</td> <td><input type="checkbox"/></td> <td>Wafer Fab Process</td> </tr> </table>						<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material	<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process	<input checked="" type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Material	<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process
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<b>PCN Details</b>																																			
<b>Description of Change:</b>																																			
This PCN is to inform of the qualification of an additional BOM materials for the list of devices in the product affected sections below.																																			
<b>Group 1 Device</b>																																			
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<b>Reason for Change:</b>																																			
Standardization																																			
<b>Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):</b>																																			
None																																			
<b>Impact on Environmental Ratings</b>																																			
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.																																			
<b>RoHS</b>		<b>REACH</b>	<b>Green Status</b>	<b>IEC 62474</b>																															
<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change																															
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BQ7790503PW	MSP430I2020TPWR	MUX36S16IPW	TLC6C5912PWR	
BQ7790503PWR	MSP430I2021TPW	MUX36S16IPWR	TLC6C598PWR	
BQ7790505PW	MSP430I2021TPWR	MUX506IPW	UCC28951PWR	
BQ7790505PWR	MSP430I2030TPW	MUX506IPWR	UCC28951PWT	
BQ7790508PW	MSP430I2030TPWR	MUX507IPW		
BQ7790508PWR	MSP430I2031TPW	MUX507IPWR		
BQ7790509PW	MSP430I2031TPWR	PGA281AIPW		

## Qualification Report

Approve Date 08-JANUARY -2025

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	#	Test Name	Condition	Duration	Qual Device: DAC8564IAPW	QBS Reference: LDC5072A0PWQ1	QBS Reference: TLC59116TPWRQ1	QBS Reference: SN36A0801GPWRQ
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	3/231/0	3/231/0	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	3/231/0	3/231/0	3/231/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	3/231/0	-	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	-	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	175C	1000 Hours	-	3/231/0	-	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	-	1/45/0	-
HTOL	B1	Life Test	125C	1000 Hours	-	-	-	3/231/0
HTOL	B1	Life Test	125C	408 Hours	-	-	1/77/0	-
HTOL	B1	Life Test	150C	3053 Hours	-	3/231/0	-	-
HTOL	B1	Life Test	160C	500 Hours	-	3/231/0	-	-
ELFR	B2	Early Life Failure Rate	150C	48 Hours	-	3/2400/0	-	-
SD	C3	PB Solderability	Precondition w.155C Steam Age (8 hrs +/- 15 minutes)	-	-	1/15/0	-	-
SD	C3	PB-Free Solderability	Precondition w.155C Steam Age (8 hrs +/- 15 minutes)	-	-	1/15/0	-	-
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes); PB-Free Solder;	-	1/22/0	-	-	-
PD	C4	Physical Dimensions	Cpk>1.67	-	-	-	-	1/10/0
ESD	E2	ESD CDM	-	1500 Volts	-	1/3/0	1/3/0	-
ESD	E2	ESD CDM	-	500 Volts	-	-	-	1/3/0
ESD	E2	ESD CDM	-	750 Volts	-	1/3/0	-	-
ESD	E2	ESD HBM	-	2000 Volts	-	-	1/3/0	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	1/3/0	-	-
LU	E4	Latch-Up	Per JESD78	-	-	1/6/0	1/6/0	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	3/90/0	-	-	-
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-	-	-	3/90/0	3/90/0

QBS: Qual By Similarity, also known as Generic Data

Qual Device DAC8564IAPW is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

## Qualification Report

Approve Date 12-May-2016

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: ADS1213U	Qual Device: ADS820U	Qual Device: ADS8504IBDW	Qual Device: MSP430F123IDWR	Qual Device: SN65LBC170DW
AC	Autoclave 121C	96 Hours	1/77/0	-	1/77/0	1/77/0	1/77/0
ED	Electrical Characterization, side by side	Per datasheet parameters	Pass	Pass	Pass	-	Pass
HAST	Biased HAST, 130C/85%RH	192 Hours	-	-	-	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	-	-
HTSL	High Temp Storage Bake 170C	420 Hours	1/77/0	-	1/77/0	1/77/0	1/77/0
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	Pass	Pass
TC	Temperature Cycle, -65/150C	500 Cycles	1/77/0	3/231/0	1/77/0	1/77/0	1/77/0

Type	Test Name / Condition	Duration	Qual Device: SN65LBC170DW_SSTN	Qual Device: SN74LVC541ADW	Qual Device: SN74LVC541ADW_SSTN	QBS Package Reference: TL494IDR	QBS Package Reference: ULQ2003AQDRQ1_STDLF
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0	3/231/0	-	3/231/0
ED	Electrical Characterization, side by side	Per datasheet parameters	Pass	Pass	Pass	-	-
HAST	Biased HAST, 130C/85%RH	192 Hours	-	-	-	3/231/0	3/217/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0	3/231/0
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	3/231/0	3/231/0	-	-
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	-	-
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0	-	3/231/0

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

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Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>  
Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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